

Chip Beads (2512063017Y0)



Part Number: 2512063017Y0

MULTI- LAYER CHIP BEAD

Part Number System: Example 2512063017Y1

25	1206	301	7	Υ		1	
Chip Bead	Package Size	Impedance Code	Packaging Code	Material Code		urrent Co	de
Code		300 Ω	6= Bulk Packed	Y = Standard Signal Speed	1	≥ 1.0A	
			= Taped and Reeled 7" Reel Taped and Reeled 13" Reel	Z = High Signal Speed H = GHz Speed	3	≥ 3.0A ETC	< 4.0A

Fair- Rite offers a broad selection of cost effective multi- layer chip beads to suppress conducted EMI signals. Chip beads can be used in an array of devices such as cellular phones, computers, laptops, pagers, etc. The small package sizes accommodate automated placements and allow for a dense packaging of circuit boards.

Chip Beads are available in standard, high and GHz signal speeds.

Packaging Options:

- All multi- layer chip beads are supplied taped and reeled, if required bulk packed chip beads can be provided.

The suggested land patterns are in accordance to the latest revision of IPC-7351.

Weight: 0.03 (g)

Package Size: 1206 (3216)

Dim	mm	mm tol	nominal inch	inch misc		Reel Info	rmation			
A	1.1	±0.20	0.043			Tape Wic	th Pito	ch Parts 7"	Parts 13"	Parts 14"
В	1.6	±0.20	0.063			mm	mn	n Reel	Reel	Reel
C	3.2	±0.20	0.126			8	4	3000	10000	_
D	0.7	±0.30	0.028							
Land I	Patterns	3	•	·		Chart Lege: + Test frequ				
V		W	X	Y	Z	1 CSt HCqu	JIIC y			
1.20		2.80	1.80	1.60]				
(0.047)	")	(0.110")	(0.071")	(0.063")	_					

Typical Impedance (Ω)				
50 MHz	203			
100 MHz ⁺	300 ±25%			
500 MHz	233			
1000 MHz ⁺	-			

Electrical Prope	rties
Max DCR (Ω)	0.2
Max Current (mA)	350

The impedance values listed are typical values. The nominal impedance with a \pm -25% tolerance is specified for the \pm marked 100 MHz. Chip beads are measured for impedance on the HP 4291A and fixture HP 16192A. Chip beads are 100% tested for impedance and dc resistance.